Silicon N-Channel MOS FET

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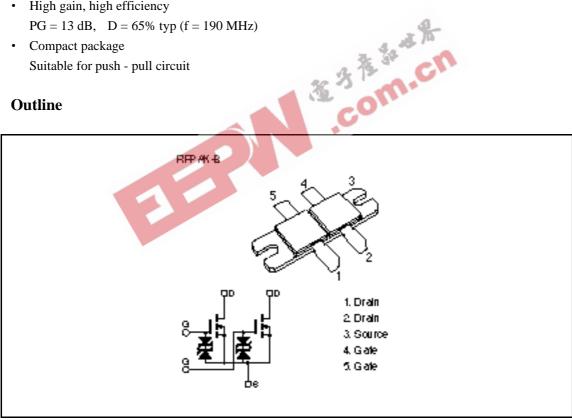
Application

VHF amplifier

Features

- High gain, high efficiency PG = 13 dB, D = 65% typ (f = 190 MHz)
- Compact package Suitable for push - pull circuit

Outline





Absolute Maximum Ratings (Ta = 25° C)

Item	Symbol	Ratings	Unit	
Drain to source voltage	V _{DSS}	180	V	
Gate to source voltage	V _{GSS}	±20	V	
Drain current	Ι _D	16	А	
Channel dissipation	Pch*1	200	W	
Channel temperature	Tch	150	°C	
Storage temperature	Tstg	-55 to +150	°C	

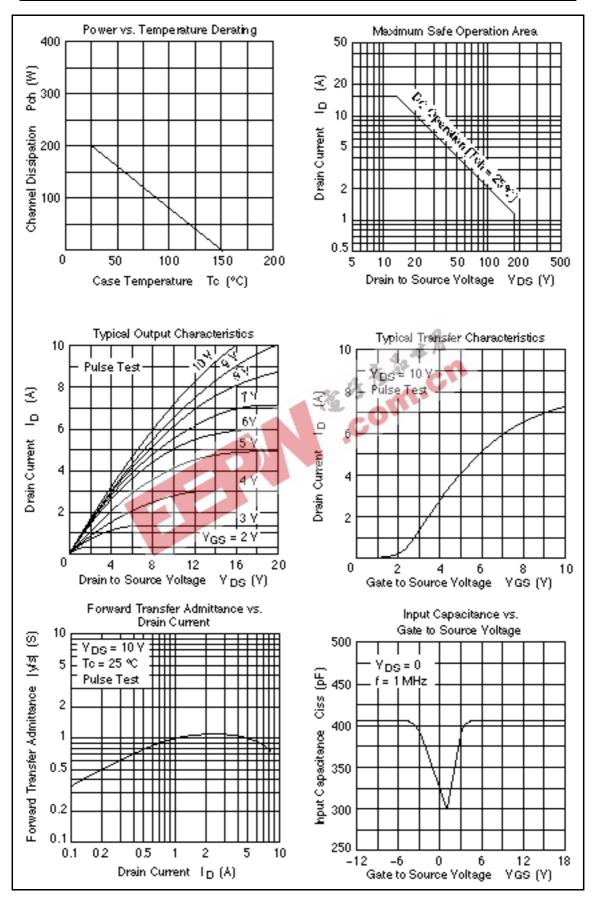
Note: 1. Value at $T_c = 25^{\circ}C$

Electrical Characteristics (Ta = 25°C)

Item	Symbol	Min	Тур	Мах	Unit	Test conditions
Drain to source breakdown voltage*1	$V_{(BR)DSS}$	180	_	_	V	$I_{\rm D} = 10$ mA, $V_{\rm GS} = 0$
Gate to source breakdown voltage*1	$V_{(BR)GSS}$	±20	—	1	v	$l_{g} = \pm 100 \ \mu A, \ V_{DS} = 0$
Zero gate voltage drain current*1	I _{DSS}	_	-%	3	mA	$V_{\rm DS} = 140 \ V, \ V_{\rm GS} = 0$
Gate to source cutoff voltage*1	$V_{\text{GS(off)}}$	0.5	L	2.0	V	$I_{\rm D}$ = 1 mA, $V_{\rm DS}$ = 10 V
Drain to source cutoff voltage*1	V _{DS(on)}	÷.	3.8	6.0	V	$I_{\rm D} = 4 \text{ A}, V_{\rm GS} = 10 \text{ V}^{*2}$
Forward transfer admittance*1	y _{fs}	0.9	1.25	_	S	$I_{D} = 3 \text{ A}, V_{DS} = 20 \text{ V}^{*2}$
Input capacitance*1	Ciss	-	440	_	pF	$V_{GS} = 5 V, V_{DS} = 0$ f = 1 MHz
Output capacitance*1	Coss	_	75	_	pF	$V_{DS} = 50 \text{ V}, \text{ V}_{GS} = 0$ f = 1 MHz
Reverse transfer capacitance*1	Crss	_	0.5	_	pF	$V_{GD} = -50 \text{ V}, \text{ f} = 1 \text{ MHz}$
Output Power	Po	180	220	_	W	$V_{\rm DS} = 80 \text{ V}, \text{ I}_{\rm DQ} = 0.2 \text{ A}$
Drain Efficiency	D		65		%	f = 190 MHz, Pin = 10 W

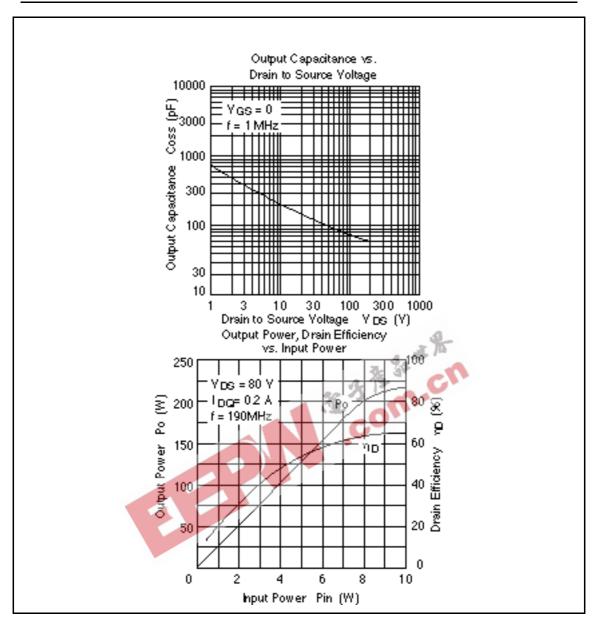
Notes: 1. Shows / unit FET

2. Pulse Test



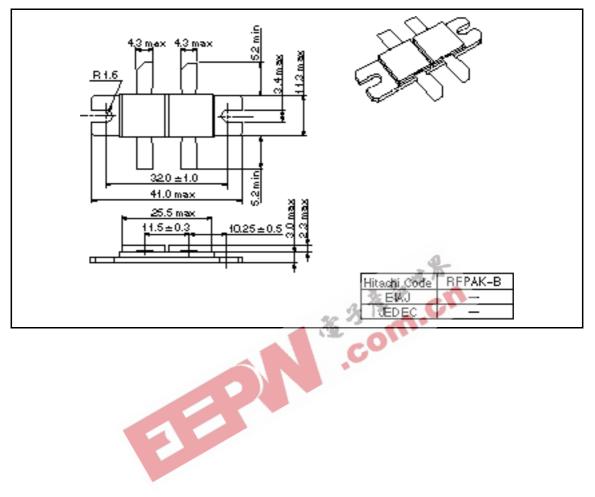
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<u>2SK1575</u>



Package Dimensions





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